



MT3202

60V N-Channel MOSFET

Features

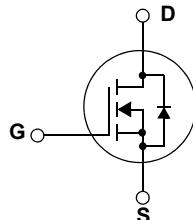
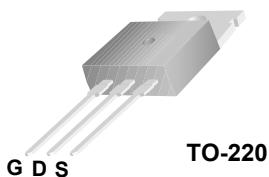
- 65A, 60V, $R_{DS(on)}$ = 0.016Ω @ V_{GS} = 10 V
- Low gate charge (typical 167nC)
- Low Crss (typical 43pF)
- Fast switching
- Improved dv/dt capability



Description

These N-Channel enhancement mode power field effect transistors are produced using Mos-tech's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies, active power factor correction, car audio, electronic lamp ballast based on half bridge topology.



Absolute Maximum Ratings

| Symbol | Parameter | MT3202 | Units |
|----------------|--|-------------|---------------------|
| V_{DSS} | Drain-Source Voltage | 60 | V |
| I_D | Drain Current - Continuous ($T_C = 25^\circ\text{C}$) | 65 | A |
| | - Continuous ($T_C = 100^\circ\text{C}$) | 40 | A |
| I_{DM} | Drain Current - Pulsed | (Note 1) | A |
| V_{GSS} | Gate-Source Voltage | ± 20 | V |
| E_{AS} | Single Pulsed Avalanche Energy | (Note 2) | mJ |
| I_{AR} | Avalanche Current | (Note 1) | A |
| E_{AR} | Repetitive Avalanche Energy | (Note 1) | mJ |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | V/ns |
| P_D | Power Dissipation ($T_C = 25^\circ\text{C}$) | 137 | W |
| | - Derate above 25°C | 1.09 | W/ $^\circ\text{C}$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | 300 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | MT3202 | Units |
|-----------------|---|--------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | 0.96 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 65.5 | $^\circ\text{C/W}$ |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|--------|---------|-----------|------------|----------|
| MT3202 | MT3202 | TO-220 | -- | -- | 50 |

Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|---|---|--|-----|-------|-------|---------------------------|
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | -- | -- | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \mu\text{A}$, Referenced to 25°C | -- | 0.5 | -- | $\text{V}/^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}} = 60 \text{ V}, V_{\text{GS}} = 0 \text{ V}$ | -- | -- | 1 | μA |
| | | $V_{\text{DS}} = 48 \text{ V}, T_C = 125^\circ\text{C}$ | -- | -- | 10 | μA |
| I_{GSSF} | Gate-Body Leakage Current, Forward | $V_{\text{GS}} = 20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$ | -- | -- | 100 | nA |
| I_{GSSR} | Gate-Body Leakage Current, Reverse | $V_{\text{GS}} = -20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$ | -- | -- | -100 | nA |
| On Characteristics | | | | | | |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$ | 2.0 | -- | 4.0 | V |
| $R_{\text{DS(on)}}$ | Static Drain-Source On-Resistance | $V_{\text{GS}} = 10 \text{ V}, I_D = 32.5 \text{ A}$ | -- | 0.016 | 0.019 | Ω |
| g_{FS} | Forward Transconductance | $V_{\text{DS}} = 40 \text{ V}, I_D = 32.5 \text{ A}$ (Note 4) | -- | 35 | -- | S |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$ | -- | 1790 | 2190 | pF |
| C_{oss} | Output Capacitance | | -- | 482 | 625 | pF |
| C_{rss} | Reverse Transfer Capacitance | | -- | 43 | 55 | pF |
| Switching Characteristics | | | | | | |
| $t_{\text{d(on)}}$ | Turn-On Delay Time | $V_{\text{DD}} = 30 \text{ V}, I_D = 65 \text{ A}, R_G = 25 \Omega$ | -- | 26 | 59 | ns |
| t_r | Turn-On Rise Time | | -- | 96 | 208 | ns |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time | | -- | 99 | 214 | ns |
| t_f | Turn-Off Fall Time | | -- | 55 | 117 | ns |
| Q_g | Total Gate Charge | $V_{\text{DS}} = 48 \text{ V}, I_D = 65 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ | -- | 33 | 43 | nC |
| Q_{gs} | Gate-Source Charge | | -- | 10 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | -- | 11 | -- | nC |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain-Source Diode Forward Current | -- | -- | 65 | -- | A |
| I_{SM} | Maximum Pulsed Drain-Source Diode Forward Current | -- | -- | 240 | -- | A |
| V_{SD} | Drain-Source Diode Forward Voltage | $V_{\text{GS}} = 0 \text{ V}, I_S = 65 \text{ A}$ | -- | -- | 1.4 | V |
| t_{rr} | Reverse Recovery Time | $V_{\text{GS}} = 0 \text{ V}, I_S = 65 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$ | -- | 62 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | (Note 4) | -- | 132 | -- | nC |

NOTES:

1. Repetitive Rating : Pulse width limited by maximum junction temperature

2. $L = 47 \mu\text{H}, I_{AS} = 65 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$

3. $I_{SD} \leq 65 \text{ A}, dI/dt \leq 200 \text{ A}/\mu\text{s}, V_{DD} \leq \text{BV}_{\text{DSS}}$, Starting $T_J = 25^\circ\text{C}$

4. Pulse Test : Pulse width $\leq 300 \mu\text{s}$, Duty cycle $\leq 2\%$

5. Essentially independent of operating temperature

Typical Performance Characteristics

Figure 1. On-Region Characteristics

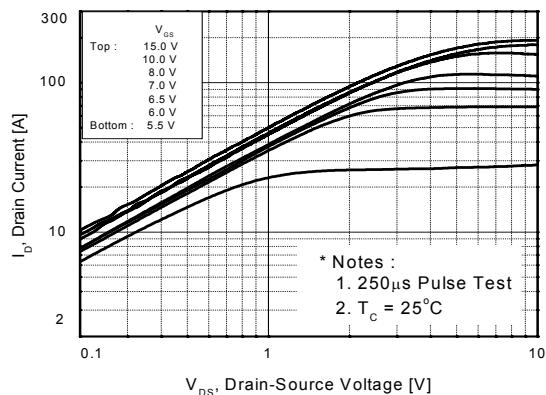


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

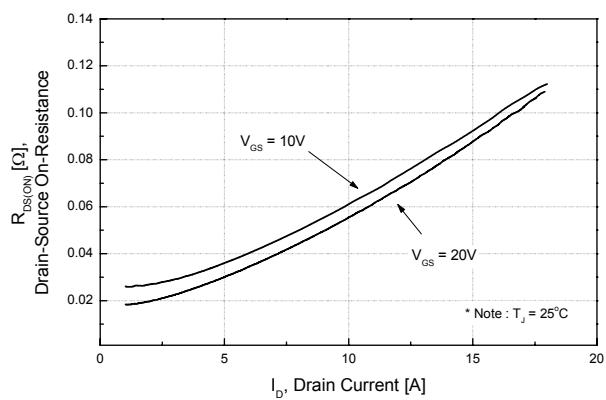


Figure 5. Capacitance Characteristics

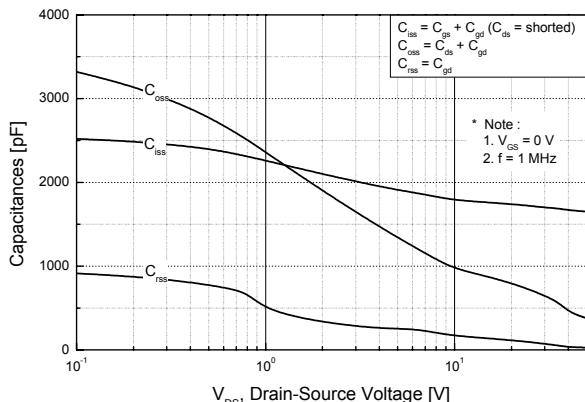


Figure 2. Transfer Characteristics

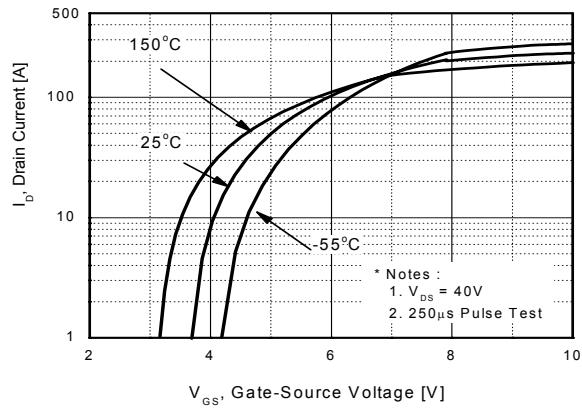


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

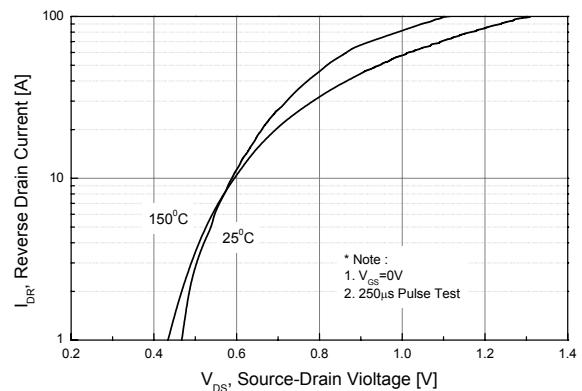
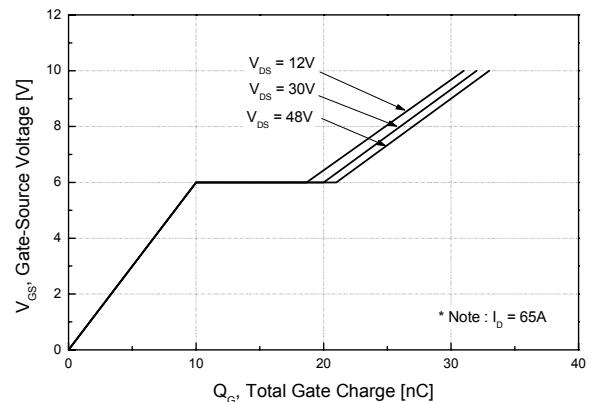


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

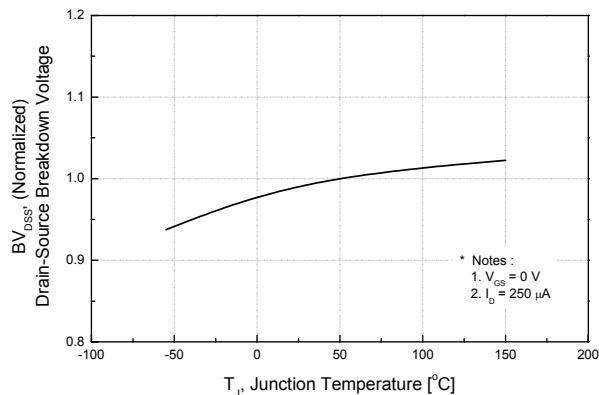


Figure 8. On-Resistance Variation vs. Temperature

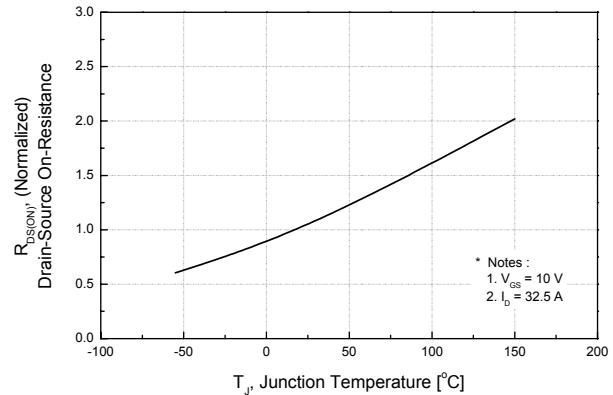


Figure 9. Maximum Safe Operating Area

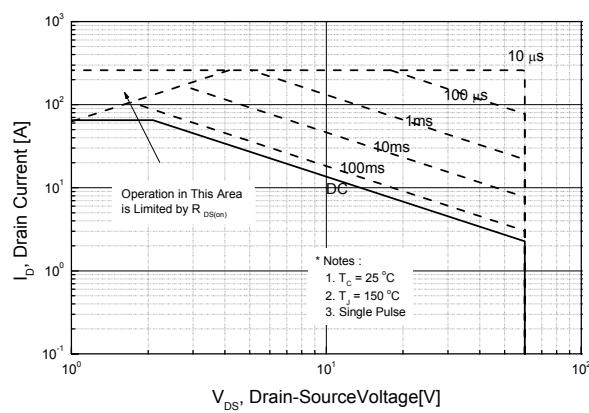


Figure 10. Maximum Drain Current vs. Case Temperature

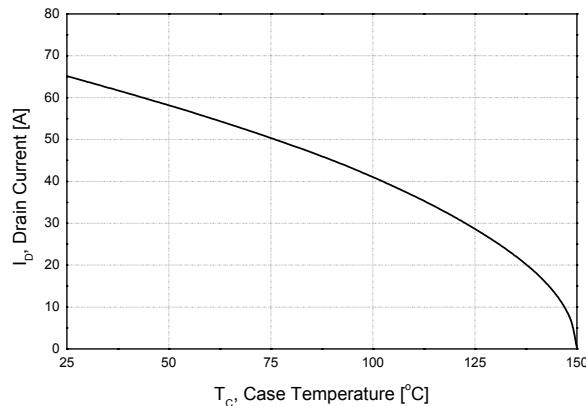
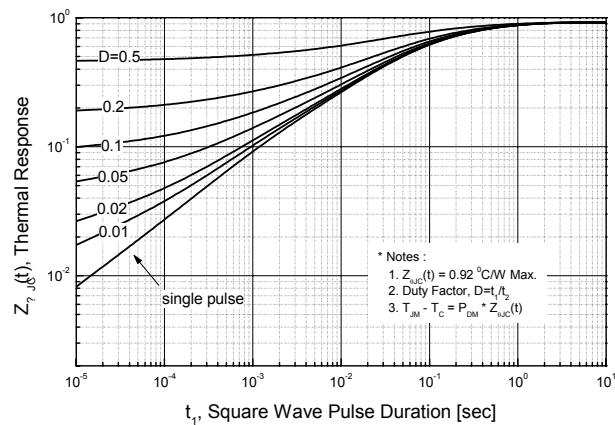
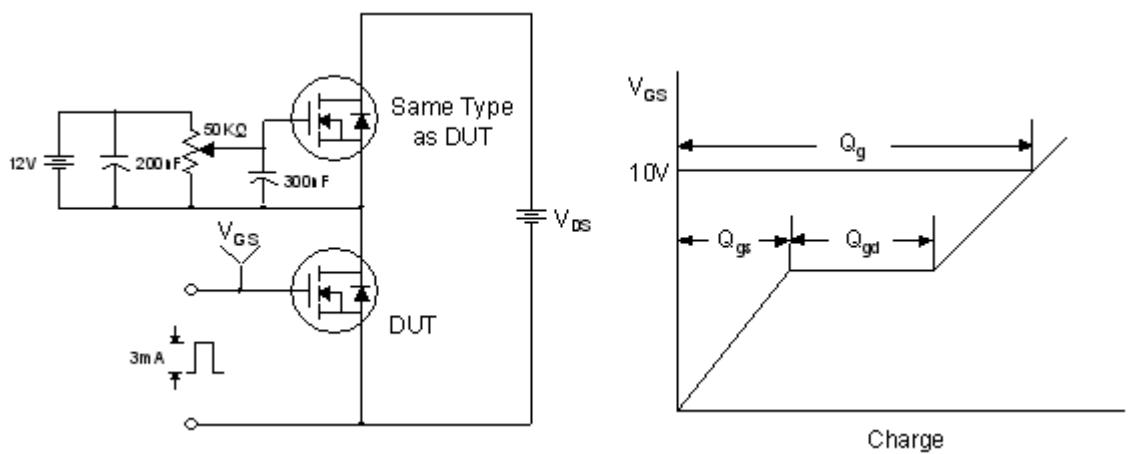


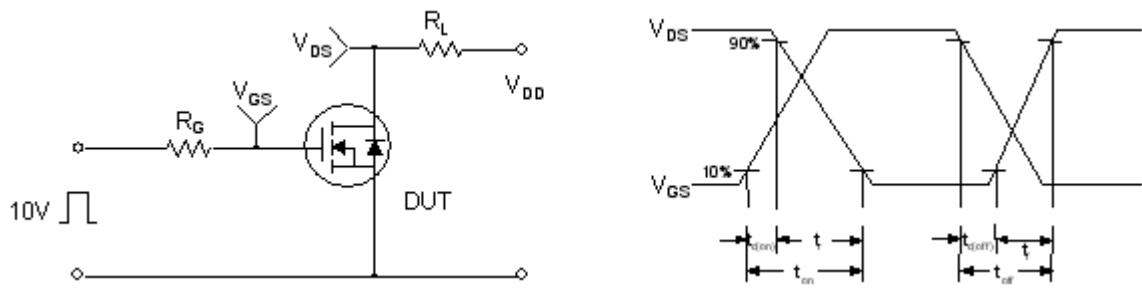
Figure 11. Transient Thermal Response Curve



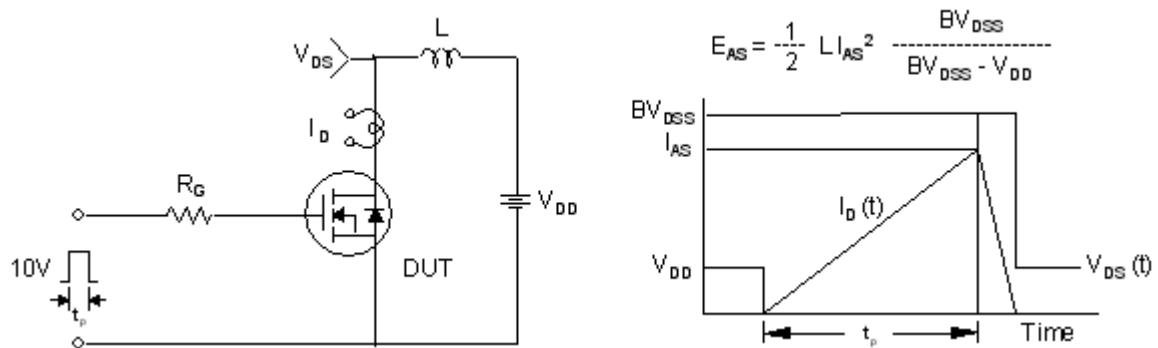
Gate Charge Test Circuit & Waveform



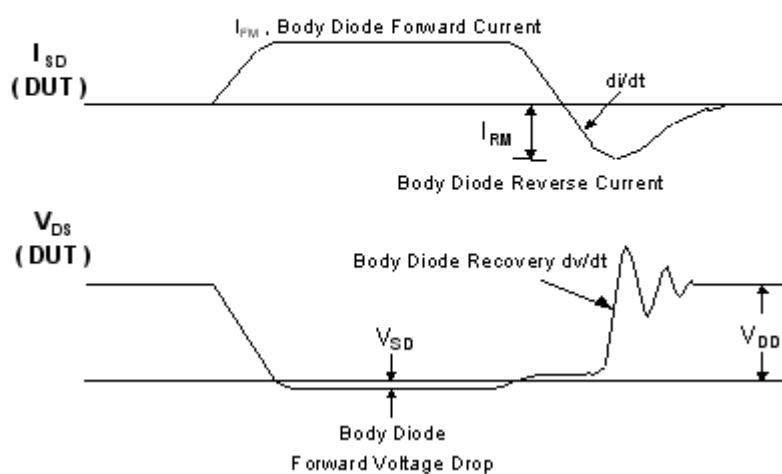
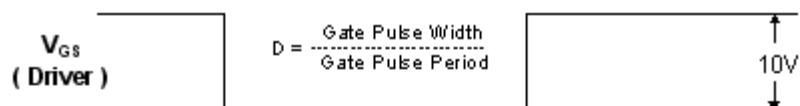
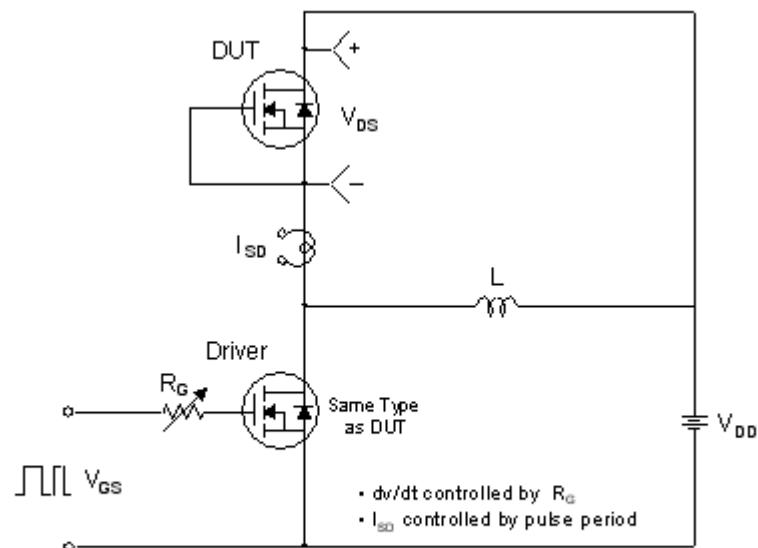
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

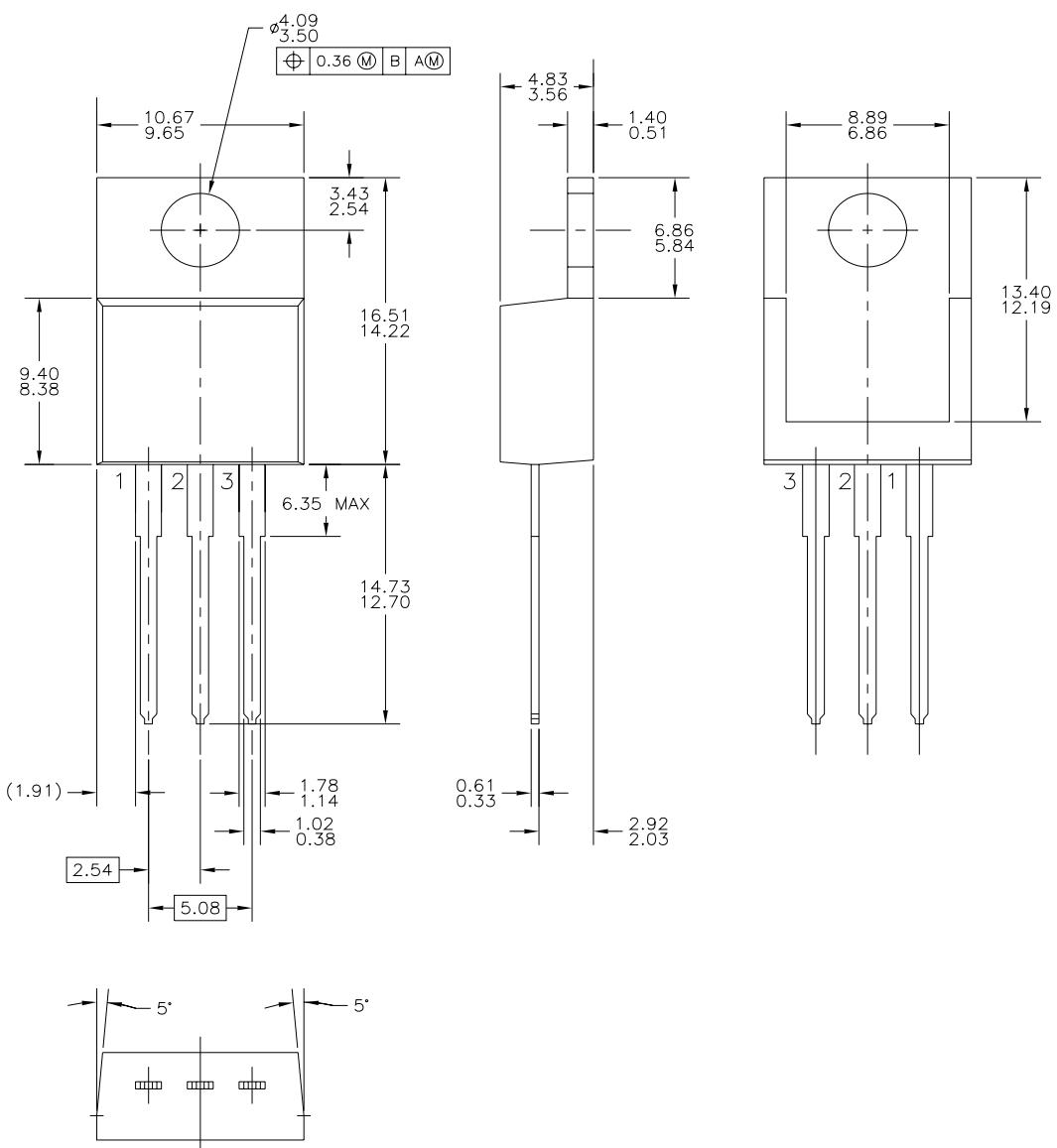


Peak Diode Recovery dv/dt Test Circuit & Waveforms



Mechanical Dimensions

TO-220



Dimensions in Millimeters